

TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

**TC74HC7240AP, TC74HC7240AF  
TC74HC7244AP, TC74HC7244AF**

**OCTAL BUS BUFFER (WITH SCHMITT TRIGGER INPUTS)**

**TC74HC7240AP / AF    INVERTED, 3 – STATE OUTPUTS**  
**TC74HC7244AP / AF    NON – INVERTED, 3 – STATE OUTPUTS**

The TC74HC7240A/7244A are high speed CMOS OCTAL BUS BUFFERs with silicon gate C<sup>2</sup>MOS technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

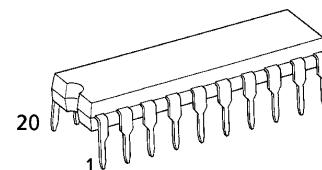
The TC74HC7240A/7244A have same pin configuration and function as the TC74HC240A/244A. And they have a hysteresis characteristics with each input, so TC74HC7240A/7244A can be used as a line receiver, etc.

They have two active low output enables.

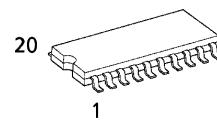
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

**FEATURES :**

- High Speed..... $t_{pd} = 15\text{ns}(\text{typ.})$  at  $V_{CC} = 5\text{V}$
- Low Power Dissipation..... $I_{CC} = 4\mu\text{A}(\text{Max.})$  at  $T_a = 25^\circ\text{C}$
- High Noise Immunity..... $V_H = 1.1\text{V}(\text{typ.})$  at  $V_{CC} = 5\text{V}$
- Output Drive Capability..... 15 LSTTL Loads
- Symmetrical Output Impedance...  $|I_{OH}| = I_{OL} = 6\text{mA}(\text{Min.})$
- Balanced Propagation Delays..... $t_{pLH} \approx t_{pHL}$
- Wide Operating Voltage Range....  $V_{CC} (\text{opr.}) = 2\text{V} \sim 6\text{V}$
- Pin and Function Compatible with 74LS240/244



P (DIP20-P-300-2.54A)  
Weight : 1.30g (Typ.)



F (SOP20-P-300-1.27)  
Weight : 0.22g (Typ.)

**TRUTH TABLE**

INPUTS		OUTPUTS	
$\bar{G}$	$A_n$	$Y_n$	$\bar{Y}_n\Delta$
L	L	L	H
L	H	H	L
H	X	Z	Z

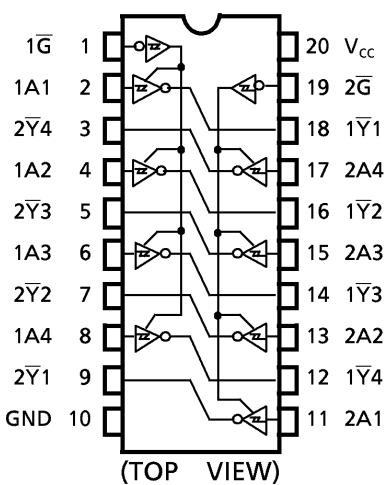
$\Delta$  : for TC74HC7240A only

X : Don't Care

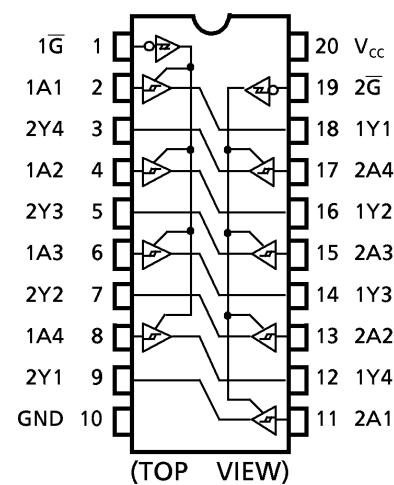
Z : High Impedance

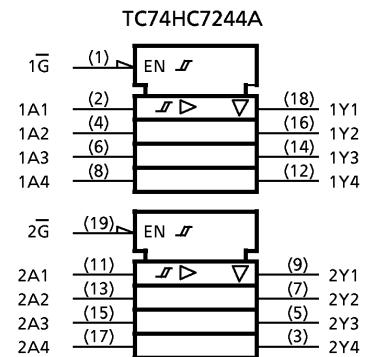
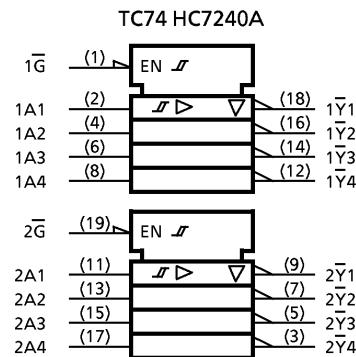
**PIN ASSIGNMENT**

TC74HC7240A



TC74HC7244A



**IEC LOGIC SYMBOL**

## ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	$V_{CC}$	-0.5~7	V
DC Input Voltage	$V_{IN}$	-0.5~ $V_{CC} + 0.5$	V
DC Output Voltage	$V_{OUT}$	-0.5~ $V_{CC} + 0.5$	V
Input Diode Current	$I_{IK}$	$\pm 20$	mA
Output Diode Current	$I_{OK}$	$\pm 20$	mA
DC Output Current	$I_{OUT}$	$\pm 35$	mA
DC $V_{CC}$ / Ground Current	$I_{CC}$	$\pm 75$	mA
Power Dissipation	$P_D$	500 (DIP)* / 180 (SOP)	mW
Storage Temperature	$T_{STG}$	-65~150	°C

\*500mW in the range of  $T_a = -40^{\circ}\text{C} \sim 65^{\circ}\text{C}$ . From  $T_a = 65^{\circ}\text{C}$  to  $85^{\circ}\text{C}$  a derating factor of  $-10\text{mW}/^{\circ}\text{C}$  shall be applied until 300mW.

## RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	$V_{CC}$	2~6	V
Input Voltage	$V_{IN}$	0~ $V_{CC}$	V
Output Voltage	$V_{OUT}$	0~ $V_{CC}$	V
Operating Temperature	$T_{OPR}$	-40~85	°C

## DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION	$V_{CC}$ (V)	Ta = 25°C			Ta = -40~85°C		UNIT
				MIN.	TYP.	MAX.	MIN.	MAX.	
Positive Threshold Voltage	$V_P$		2.0 4.5 6.0	1.0 2.3 3.0	1.25 2.7 3.5	1.5 3.15 4.2	1.0 2.3 3.0	1.5 3.15 4.2	V
Negative Threshold Voltage	$V_N$		2.0 4.5 6.0	0.3 1.13 1.5	0.65 1.6 2.3	0.9 2.0 2.6	0.3 1.13 1.5	0.9 2.0 2.6	V
Hysteresis Voltage	$V_H$		2.0 4.5 6.0	0.3 0.6 0.8	0.6 1.1 1.2	1.0 1.4 1.7	0.3 0.6 0.8	1.0 1.4 1.7	V
High - Level Output Voltage	$V_{OH}$	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OH} = -20\mu\text{A}$	2.0 4.5 6.0	1.9 4.4 5.9	2.0 4.5 6.0	— — —	1.9 4.4 5.9	— — —
			$I_{OH} = -6\text{ mA}$ $I_{OH} = -7.8\text{ mA}$	4.5 6.0	4.18 5.68	4.31 5.80	— —	4.13 5.63	— —
Low - Level Output Voltage	$V_{OL}$	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OL} = 20\mu\text{A}$	2.0 4.5 6.0	— — —	0.0 0.0 0.0	0.1 0.1 0.1	— — —	0.1 0.1 0.1
			$I_{OL} = 6\text{ mA}$ $I_{OL} = 7.8\text{ mA}$	4.5 6.0	— —	0.17 0.18	0.26 0.26	— —	0.33 0.33
3 - State Output Off - State Current	$I_{OZ}$	$V_{IN} = V_{IH}$ or $V_{IL}$ $V_{OUT} = V_{CC}$ or GND	6.0	—	—	$\pm 0.5$	—	$\pm 5.0$	$\mu\text{A}$
Input Leakage Current	$I_{IN}$	$V_{IN} = V_{CC}$ or GND	6.0	—	—	$\pm 0.1$	—	$\pm 1.0$	
Quiescent Supply Current	$I_{CC}$	$V_{IN} = V_{CC}$ or GND	6.0	—	—	4.0	—	40.0	

AC ELECTRICAL CHARACTERISTICS (Input  $t_r = t_f = 6\text{ns}$ )

PARAMETER	SYMBOL	TEST CONDITION	CL (PF)	$V_{CC}(\text{V})$	$T_a = 25^\circ\text{C}$			$T_a = -40\text{--}85^\circ\text{C}$		UNIT
					MIN.	TYP.	MAX.	MIN.	MAX.	
Output Transition Time	$t_{TLH}$		50	2.0	—	25	60	—	75	ns
	$t_{THL}$			4.5	—	7	12	—	15	
				6.0	—	6	10	—	13	
Propagation Delay Time	$t_{pLH}$		50	2.0	—	50	125	—	155	ns
	$t_{pHL}$			4.5	—	15	25	—	31	
				6.0	—	13	21	—	26	
	$t_{pLH}$		150	2.0	—	67	165	—	205	
	$t_{pHL}$			4.5	—	20	33	—	41	
				6.0	—	17	28	—	35	
Output Enable Time	$t_{pZL}$		50	2.0	—	68	150	—	190	ns
	$t_{pZH}$			4.5	—	21	30	—	38	
				6.0	—	16	26	—	32	
	$t_{pLZ}$		150	2.0	—	84	165	—	230	
	$t_{pHZ}$			4.5	—	26	37	—	46	
				6.0	—	20	31	—	39	
Output Disable Time	$t_{pLZ}$	$R_L = 1\text{k}\Omega$	50	2.0	—	48	150	—	190	pF
	$t_{pHZ}$			4.5	—	21	30	—	38	
				6.0	—	19	26	—	32	
Input Capacitance	$C_{IN}$				—	5	10	—	10	pF
Output Capacitance	$C_{OUT}$				—	10	—	—	—	
Power Dissipation Capacitance	$C_{PD}(1)$	TC74HC7240A			—	33	—	—	—	
		TC74HC7244A				34	—	—	—	

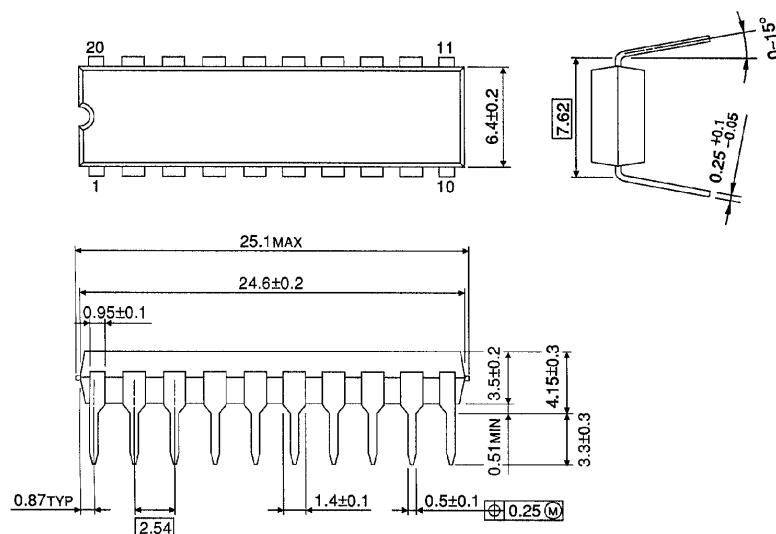
Note (1)  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation :

$$I_{CC}(\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

## DIP 20PIN PACKAGE DIMENSIONS (DIP20-P-300-2.54A)

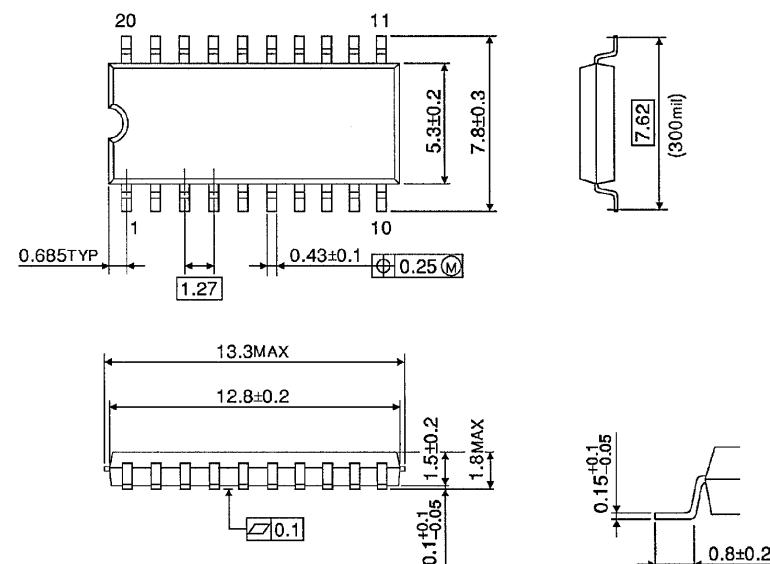
Unit in mm



Weight : 1.30g (Typ.)

## SOP 20PIN (200mil BODY) PACKAGE DIMENSIONS (SOP20-P-300-1.27)

Unit in mm



Weight : 0.22g (Typ.)

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000707EBA

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